


SOLID STATE DEVICES, INC
PRELIMINARY

 14849 Firestone Boulevard · La Mirada, CA 90638
 Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

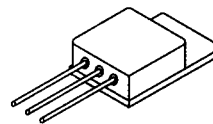
Designer's Data Sheet

FEATURES:

- Rugged construction with poly silicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Hermetically sealed package
- TX, TXV and Space Level screening available
- Replaces: IRFY130 Types

SFF130J

**14 AMP
100 VOLTS
0.16 Ω
N-CHANNEL
POWER MOSFET**

TO-257


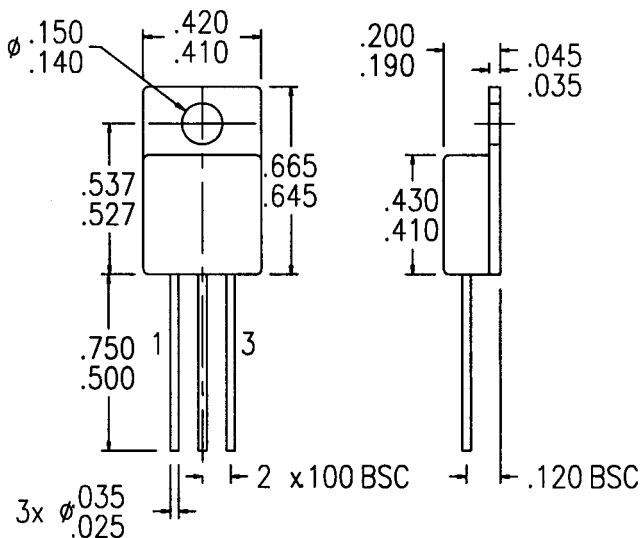
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V _{DS}	100	Volts
Gate to Source Voltage	V _{GS}	± 20	Volts
Continuous Drain Current @ TC=25°C @ TC=100°C	I _D	14 9	Amps
Operating and Storage Temperature	Top & Tstg	-55 to +150	°C
Thermal Resistance, Junction to Case	R _{θJC}	2.5	°C/W
Total Device Dissipation @ TC=25°C Total Device Dissipation @ TC=55°C	P _D	50 38	Watts

PACKAGE OUTLINE: TO-257

PIN OUT:

PIN 1: DRAIN
PIN 2: SOURCE
PIN 3: GATE



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00025 B
MED

SFF130J

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Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424**ELECTRICAL CHARACTERISTICS @ T_J=25°C (Unless Otherwise Specified)**

RATING		SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage (V _{GS} =0 V, I _D =250μA)		BV _{DSS}	100	---	---	V
Temperature Coefficient of Breakdown Voltage		$\frac{\Delta BV_{DSS}}{\Delta T_J}$	---	0.13	---	V/°C
Drain to Source on State Resistance (V _{GS} =10 V) I _D = 9A I _D = 14A		R _{DS(on)}	---	0.13 0.14	0.18 0.21	Ω
On State Drain Current (V _D > I _{D(on)} X R _{DS(on)} Max, V _{GS} =10 V)		I _{D(on)}	14	---	---	A
Gate Threshold Voltage (V _D =V _{GS} , I _D =250μA)		V _{GS(th)}	2	2.8	4	V
Forward Transconductance (V _D > I _{D(on)} X R _{DS(on)} Max, I _{DS} =60% rated I _D)		g _{fs}	4.6	7	--	S(V)
Zero Gate Voltage Drain Current (V _D =80% rated voltage, V _{GS} =0 V) (V _D =80% rated V _D , V _{GS} =0 V, T _A =125°C)		I _{DSS}	---	---	25 250	μA
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated V _{GS}	I _{GSS}	---	---	100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	V _{GS} =10 Volts 50% rated V _D Rated I _D	Q _g Q _{gs} Q _{gd}	12 1.5 5	20 --- ---	35 10 15	nC
Turn on Delay Time Rise Time Turn Off Delay Time Fall Time	V _{DD} =50% rated V _D I _D = 14A R _G =7.5Ω	t _{d(on)} t _r t _{d(off)} t _f	--- --- --- ---	9.5 42 22 25	35 80 60 45	nsec
Diode Forward Voltage (I _S =rated I _D , V _{GS} =0 V, T _J =25°C)		V _{SD}	---	1.15	1.5	V
Diode Reverse Recovery Time Reverse Recovery Charge	T _J =25°C I _F =rated I _D di/dt=100 A/μsec	t _{rr} Q _{RR}	--- ---	120 0.7	300 3	nsec μC
Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{GS} =0 Volts V _D =25 Volts f=1 MHz	C _{iss} C _{oss} C _{rss}	--- --- ---	650 250 44	--- --- ---	pF

SAFE OPERATING AREA (S.O.A.)
T_C = 25°C, D.C. CONDITION